Course code		Course Name		L-T-P-Credits Yea		r of Introduction			
ME407		MECHATRONICS		3-0-0-3	3-0-0-3		2016		
Prerequisite: Nil									
 Course Objectives: To introduce the features of various sensors used in CNC machines and robots To study the fabrication and functioning of MEMS pressure and inertial sensors To enable development of hydraulic/pneumatic circuit and PLC programs for simple applications 									
Syllabus Introduction to Mechatronics, sensors, Actuators, Micro Electro Mechanical Systems (MEMS), Mechatronics in Computer Numerical Control (CNC) machines, Mechatronics in Robotics-Electrical drives, Force and tactile sensors, Image processing techniques, Case studies of Mechatronics systems.									
Expected The stude i. ii. Text Boo 1. Bolto Perso 2. Rama Mech 3. Saeed New 2. Reference 1. David McGr 2. Gorde	l outcom ents will b Know Integra mecha oks: n W., M n Educat chandrar anical El b. Niku Delhi, 20 ces Books d G. Alda caw-Hill 1 on M. Ma	e: be able to the mechanical syste te mechanical, electre tronics systems echatronics: Electron ion Limited, New De K. P., G. K. Vija ectronic Systems, Wi a, Introduction to Rob 06. S: tore, Michael B. His Inc., USA, 2003. air, Industrial Robotic	ems used in mechatron onics, control and con nic Control Systems i lhi, 2007 ayaraghavan, M. S. ley India Pvt. Ltd., Ne potics: Analysis, Syste stand, Introduction to	nics nputer engineering i n Mechanical and Balasundaram, Me ew Delhi, 2008. ems, Applications, 1 Mechatronics and hational, UK, 1998.	in the d Electric echatron Person Measur	lesign of cal Engin nics: Inte Educatio ement Sy	eering, egrated n, Inc., ystems,		
 HMT, Mechatronics, Tata McGraw-Hill Publishing Company Ltd., New Delhi, 2004. Vijay K. Varadan, K. J. Vinoy, S. Gopalakrishnan, Smart Material Systems and MEMS: Design and Development Methodologies. John Wiley & Sons Ltd. England, 2006. 									
	1		Course Plan		1				
Module			Contents		6	Hours	End Sem. Exam Marks		
I	Introdu - Char position inducti and abs sensors sensors	ction to Mechatronic acteristics -Temperat and proximity s ve, capacitive and ec solute, gray coded en . Acoustic Emissior	s: Structure of Mecha ture, flow, pressure sensing by magnetic ddy current methods. coder. Resolvers and a sensors. Principle a	tronics system. Sen sensors. Displacem c, optical, ultrasc Encoders: increme synchros. Piezoelee and types of vibra	sors nent, onic, ental ctric ttion	8	15%		

п	Actuators: Hydraulic and Pneumatic actuators - Directional control valves, pressure control valves, process control valves. Rotary actuators. Development of simple hydraulic and pneumatic circuits using standard Symbols.	7	15%						
FIRST INTERNAL EXAM									
III	Micro Electro Mechanical Systems (MEMS): Fabrication: Deposition, Lithography, Micromachining methods for MEMS, Deep Reactive Ion Etching (DRIE) and LIGA processes. Principle, fabrication and working of MEMS based pressure sensor, accelerometer and gyroscope.	6	15%						
IV	Mechatronics in Computer Numerical Control (CNC) machines: Design of modern CNC machines - Mechatronics elements - Machine structure: guide ways, drives. Bearings: anti-friction bearings, hydrostatic bearing and hydrodynamic bearing. Re-circulating ball screws, pre-loading methods. Re-circulating roller screws. Typical elements of open and closed loop control systems. Adaptive controllers for machine tools. Programmable Logic Controllers (PLC) –Basic structure, input/ output processing. Programming: Timers, Internal Relays, Counters and Shift registers. Development of simple ladder programs for specific purposes.	8	15%						
SECOND INTERNAL EXAM									
V	 System modeling - Mathematical models and basic building blocks of general mechanical, electrical, fluid and thermal systems. Mechatronics in Robotics-Electrical drives: DC, AC, brushless, servo and stepper motors. Harmonic drive. Force and tactile sensors. Range finders: ultrasonic and light based range finders 	6	20%						
VI	 Robotic vision system - Image acquisition: Vidicon, charge coupled device (CCD) and charge injection device (CID) cameras. Image processing techniques: histogram processing: sliding, stretching, equalization and thresholding. Case studies of Mechatronics systems: Automatic camera, bar code reader, pick and place robot, automatic car park barrier system, automobile engine management system. 	7	20%						
END SEMESTER EXAM									

Question Paper Pattern

Maximum marks: 100

Time: 3 hrs

The question paper should consist of three parts

Part A

There should be 2 questions each from module I and II. Each question carries 10 marks. Students will have to answer any three questions out of 4 (3X10 = 30 marks)

Part B

There should be 2 questions each from module III and IV. Each question carries 10 marks. Students will have to answer any three questions out of 4 (3X10 marks = 30 marks)

Part C

There should be 3 questions each from module V and VI. Each question carries 10 marks Students will have to answer any four questions out of 6 (4X10 marks =40 marks)

Note: Each question can have a maximum of four sub questions, if needed.